IPC ASSOCIATION CO ELECTRONICS IN	© Copyright 2005. IP	mposition Declaration 05. IPC, Bannockburn, Illinois. All rights reserved under both I Pan-American copyright conventions.		This docur level parts.	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi				ials and Mfg Information				
upplier Iı	nformation													
Company name*			Company unique ID			Unique ID Authority				Response Date*				
nsemi							l				2025-05-10			
Contact Name			Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com					
R	Requester Item Number		Mfr Item Number Mfr Item Name			Effective D	ate V	Version Manufacturing Site		Wei	ght*	UOM	Unit Type	
		NXH300 PG	B100H4Q2F2	Mass market 250k	xw 1500v Q2 3 Level Boos	t 2025-05-10	,	•	CNG	1762	241.16	mg	Each	
lanufactu	uring Proccess Informati	ion												
Te	Terminal Plating / Grid Array Material		Γerminal Base Alloy J-STD-020 MSL		-STD-020 MSL Rating	Peak Process Body Temperature Max Time		re Max Time at Peak	Temperature	Number	of Reflow Cyc	cles		
Matte Tin (Sn) - annealed		C	CU Alloy NA		NA	0 C 30		30	seconds 3					

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an								
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3615.5	mg
			Supplier	PBT	26062-94-2		6714.4995	mg
Case Lid	6420.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2247	mg
			Supplier	PBT	26062-94-2		4173	mg
DBC	16520.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		6608	mg
			Supplier	Copper (Cu)	7440-50-8		9912	mg
Die	261.157	mg	Supplier	Silicon Carbide	409-21-2		261.157	mg
			Supplier	Silicon (Si)	7440-21-3		0	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	4670.0	mg	Supplier	Silver (Ag)	7440-22-4		303.55	mg
			Supplier	Tin (Sn)	7440-31-5		4366.4502	mg
			Supplier	Copper (Cu)	7440-50-8		-140.0997	mg
Terminal	5210.0	mg	Supplier	Silicon (Si)	7440-21-3		14.067	mg
			В	Nickel (Ni)	7440-02-0		70.335	mg
			Supplier	Copper (Cu)	7440-50-8		5124.2954	mg
			Supplier	Phosphorus (P)	7723-14-0		1.3025	mg
Wire Bond - Al	560.0	mg	Supplier	Aluminum (Al)	7429-90-5		560	mg